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Vishay Siliconix

N-Channel 8 V (D-S) MOSFET



Marking code: F2

PRODUCT SUMMARY					
V _{DS} (V)	8				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.017				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5 \text{ V}$	0.020				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.8 \text{ V}$	0.022				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.5 \text{ V}$	0.030				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.2 \text{ V}$	0.075				
Q _g typ. (nC)	6				
I _D (A) a, e	6				
Configuration	Single				

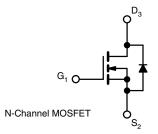
FEATURES

- TrenchFET® power MOSFET
- · Low on-resistance
- 100 % R_q tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- · Load switches for low voltage gate drive
- · Low voltage operating circuits
 - Gate drive 1.2 V to 5 V



ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	Si2342DS-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	8	V	
Gate-source voltage		V _{GS}	± 5	v	
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		6 ^e		
	T _C = 70 °C		6 ^e		
	T _A = 25 °C	I _D	6 b, c, e		
	T _A = 70 °C		5.8 ^{b, c}	A	
Pulsed drain current (t = 300 μs)		I _{DM}	30		
Continuous source-drain diode current	T _C = 25 °C		2.1		
	T _A = 25 °C	I _S	1.1 ^{b, c}		
Maximum power dissipation	T _C = 25 °C		2.5		
	T _C = 70 °C		1.6	147	
	T _A = 25 °C	P _D	1.3 ^{b, c}	W	
	T _A = 70 °C		0.8 b, c		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature)			260	°C	

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	75	100	°C/W		
Maximum junction-to-foot (drain)	Steady state	R _{th IE}	40	50	7 0/00		

Notes

- a. Based on T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
 d. Maximum under steady state conditions is 166 °C/W
- e. Package limited



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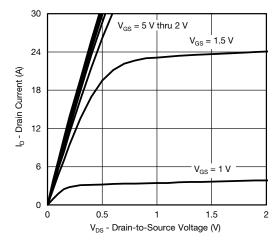
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static						•	
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	8	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	10	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-2.5	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$	0.35	-	0.8	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$	-	-	± 100	nA	
Zara gata valtaga drain avrent	,	V _{DS} = 8 V, V _{GS} = 0 V	-	-	1	, . ^	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 8 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	μA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	20	-	-	Α	
		V _{GS} = 4.5 V, I _D = 7.2 A	-	0.014	0.017	1	
		$V_{GS} = 2.5 \text{ V}, I_D = 6.7 \text{ A}$	-	0.016	0.020		
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = 1.8 V, I _D = 6.4 A	-	0.018	0.022	Ω	
		V _{GS} = 1.5 V, I _D = 5.5 A	-	0.020	0.030		
		V _{GS} = 1.2 V, I _D = 1.3 A	-	0.025	0.075		
Forward transconductance ^a	9 _{fs}	V _{DS} = 4 V, I _D = 7.2 A	-	75	-	S	
Dynamic ^b	· · · ·						
Input capacitance	C _{iss}		-	1070	-	pF	
Output capacitance	C _{oss}	$V_{DS} = 4 V$, $V_{GS} = 0 V$, $f = 1 MHz$	-	385	-		
Reverse transfer capacitance	C _{rss}		-	200	-		
Total gate charge		$V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 7.2 \text{ A}$	-	10.5	15.8	nC	
Total gate charge	Qg		-	6	9		
Gate-source charge	Q _{gs}	$V_{DS} = 4 \text{ V}, V_{GS} = 2.5 \text{ V}, I_D = 7.2 \text{ A}$	-	1.6	-		
Gate-drain charge	Q_{gd}		-	1	-		
Gate resistance	R_g	f = 1 MHz	2.4	12	24	Ω	
Turn-on delay time	t _{d(on)}		-	6	12	ns	
Rise time	t _r	$V_{DD} = 4 \text{ V}, R_{L} = 0.7 \Omega,$	-	14	20		
Turn-off delay time	t _{d(off)}	$I_D \cong 5.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	65	98		
Fall time	t _f		-	25	38		
Drain-Source Body Diode Characterist	cs						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	2.1		
Pulse diode forward current	I _{SM}		-	-	30	Α	
Body diode voltage	V_{SD}	I _S = 5.8 A, V _{GS} = 0	-	0.82	1.2	V	
Body diode reverse recovery time	t _{rr}		-	40	60	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 5.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	17	26	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	15	-		
Reverse recovery rise time	t _b		-	25	-	ns	

Notes

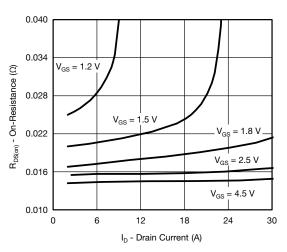
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

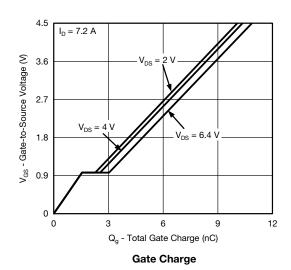


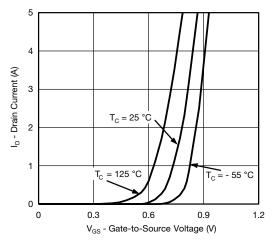


Output Characteristics

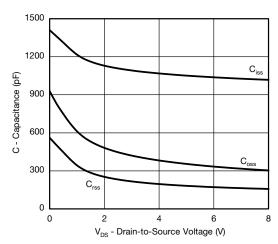


On-Resistance vs. Drain Current and Gate Voltage

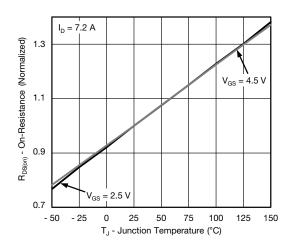




Transfer Characteristics

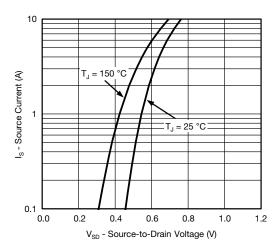


Capacitance

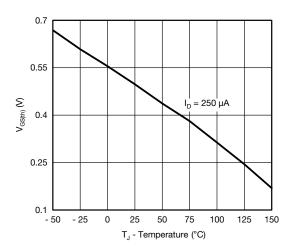


On-Resistance vs. Junction Temperature

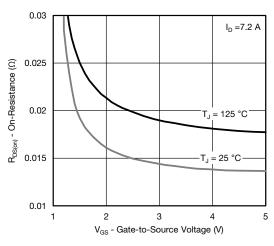




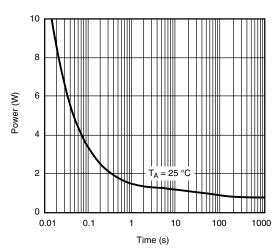
Source-Drain Diode Forward Voltage



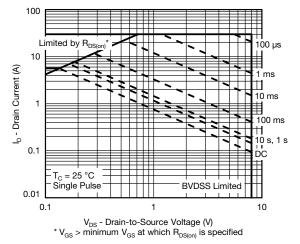
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

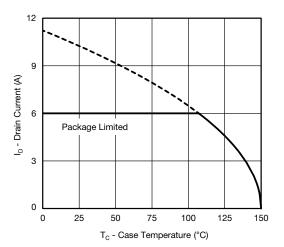


Single Pulse Power (Junction-to-Ambient)

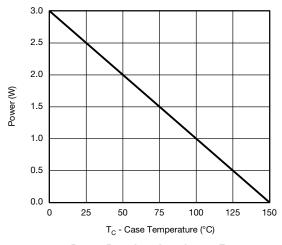


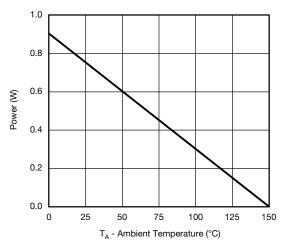
Safe Operating Area, Junction-to-Ambient





Current Derating a





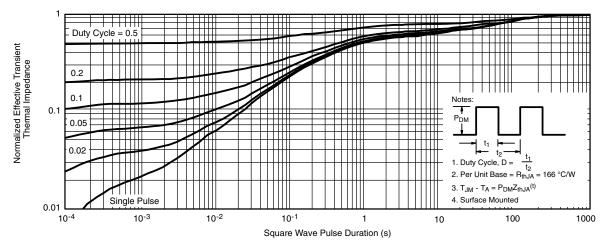
Power Derating, Junction-to-Foot

Power Derating, Junction-to-Ambient

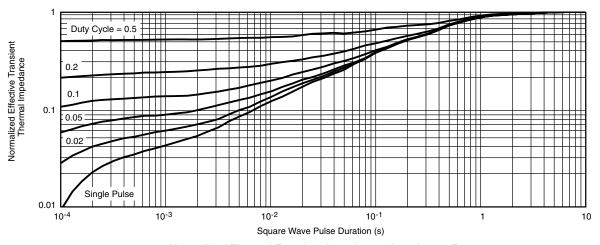
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63302.

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SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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